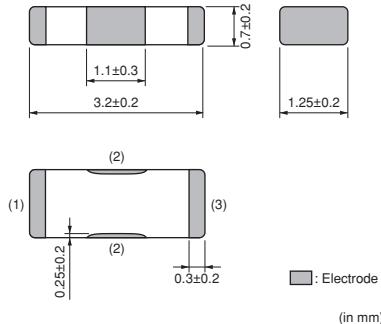


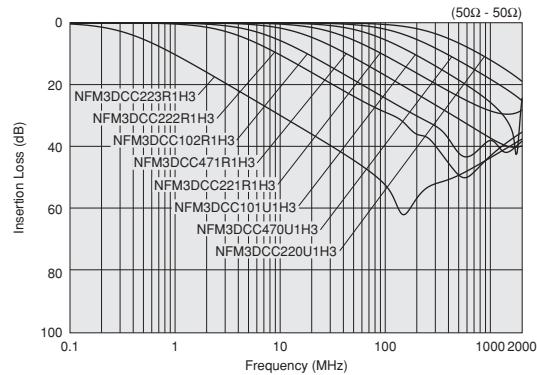
EMIFIL® (Capacitor type) Single Circuit Type for Signal Lines

NFM3DC Series (1205 Size)

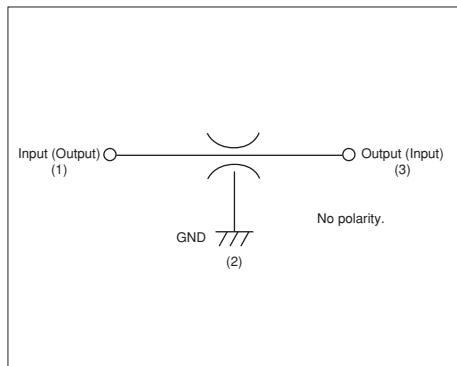
■ Dimensions



■ Insertion Loss Characteristics (Main Items)



■ Equivalent Circuit



■ Packaging

Code	Packaging	Minimum Quantity
L	180mm Embossed Tape	4000
B	Bulk(Bag)	500

■ Rated Value (□: packaging code)

Part Number	Capacitance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Operating Temperature Range
NFM3DCC220U1H3□	22pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C
NFM3DCC470U1H3□	47pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C
NFM3DCC101U1H3□	100pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C
NFM3DCC221R1H3□	220pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C
NFM3DCC471R1H3□	470pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C
NFM3DCC102R1H3□	1000pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C
NFM3DCC222R1H3□	2200pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C
NFM3DCC223R1H3□	22000pF 50/-20%	300mA	50Vdc	1000M ohm	-55 to +125°C

Number of Circuit: 1

Continued on the following page.

● This data sheet is applied for CHIP EMIFIL® used for General Electronics equipment for your design.

⚠ Note:

1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, its specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

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 Continued from the preceding page.

■ Caution/Notice

Caution (Rating)

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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